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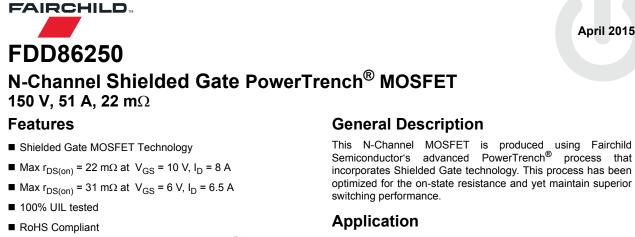


ON Semiconductor®

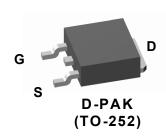
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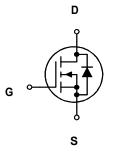
Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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DC - DC Conversion





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25 °C	(Note 5)	51		
	-Continuous	T _C = 100 °C	(Note 5)	27	_	
	-Continuous	T _A = 25 °C	(Note 1a)	8	Α	
	-Pulsed		(Note 4)	164		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	180	mJ	
P _D	Power Dissipation	T _C = 25 °C		132	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.1	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case		0.94	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	0/00

Package Marking and Ordering Information

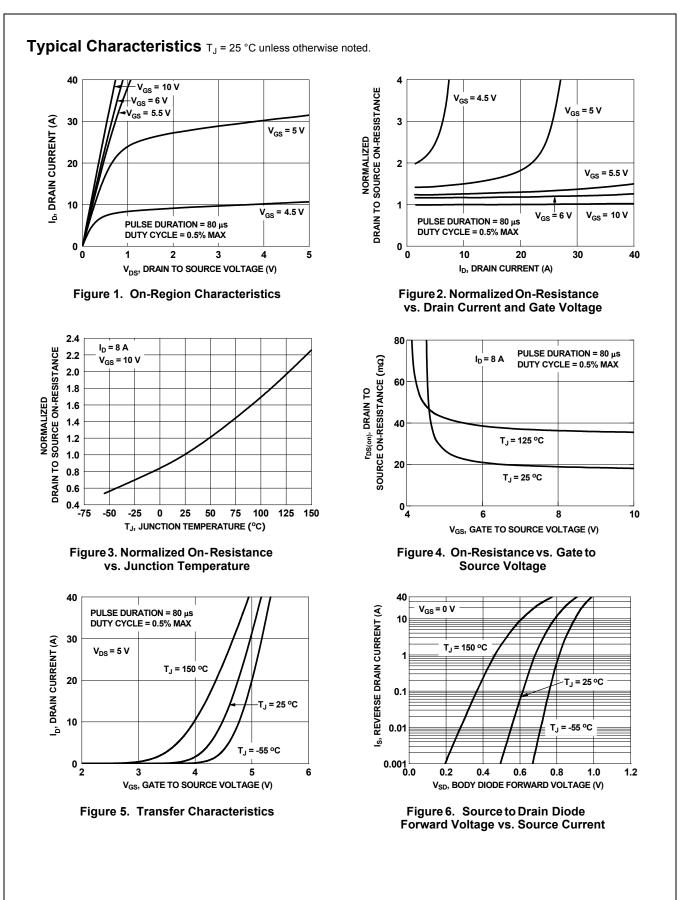
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86250	FDD86250	D-PAK(TO-252)	13 "	16 mm	2500 units

April 2015

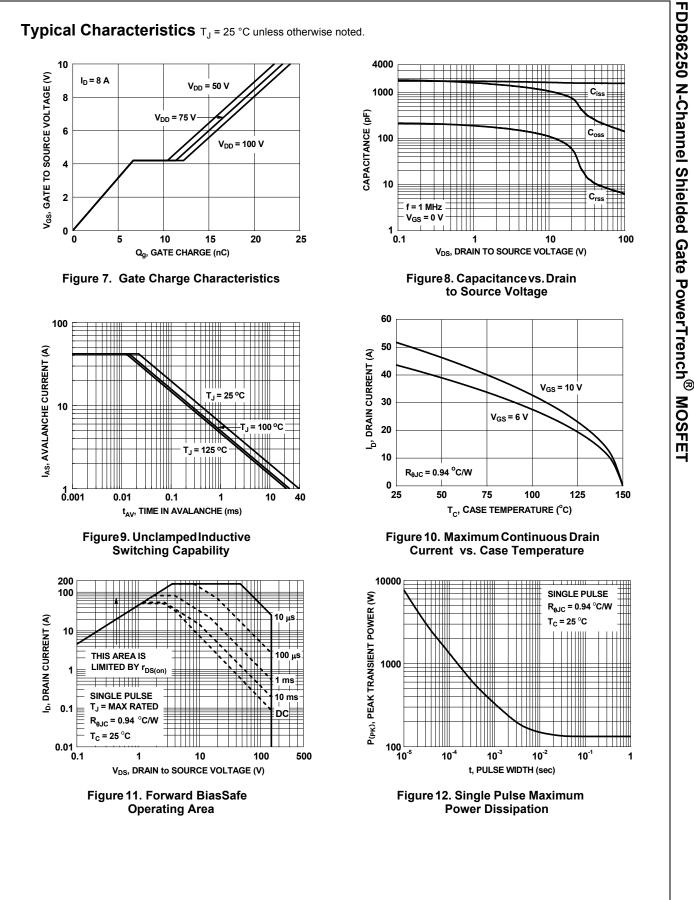
	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics			1	L.	
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150	1		V
ABV _{DSS}	Breakdown Voltage Temperature		100	106		
ΔT_{J}	Coefficient	I_D = 250 μ A, referenced to 25 °C		106		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 120 V, V_{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.9	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		-10		mV/°C
		V _{GS} = 10 V, I _D = 8 A		18.4	22	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$		21.4	31	mΩ
		V_{GS} = 10 V, I _D = 8 A, T _J = 125 °C		35.8	45	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 8 A		28		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			1585	2110	pF
C _{oss}	Output Capacitance	$V_{DS} = 75 V, V_{GS} = 0 V,$		167	225	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		7	15	pF
R _g	Gate Resistance			0.6		Ω
-	g Characteristics			L		1
t _{d(on)}	Turn-On Delay Time			11.2	20	ns
t _r	Rise Time	V _{DD} = 75 V, I _D = 8 A,		3.7	10	ns
d(off)	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		20	32	ns
t _f	Fall Time			4	10	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		23	33	nC
Qg	Total Gate Charge	V_{GS} = 0 V to 5 V V_{DD} = 75 V,		12.8	18	nC
Q _{gs}	Gate to Source Charge	I _D = 8 A		6.7		nC
	Gate to Drain "Miller" Charge			4.7		nC
Q _{gd}						
	urce Diode Characteristics					
Drain-Soເ		V _{GS} = 0 V, I _S = 8 A (Note 2)		0.78	1.3	V
Drain-Soເ	Source-Drain Diode Forward Voltage	$\frac{V_{GS} = 0 \text{ V}, \text{ I}_{S} = 8 \text{ A}}{V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.6 \text{ A}} (\text{Note 2})$		0.78 0.73	1.3 1.2	V
						V ns

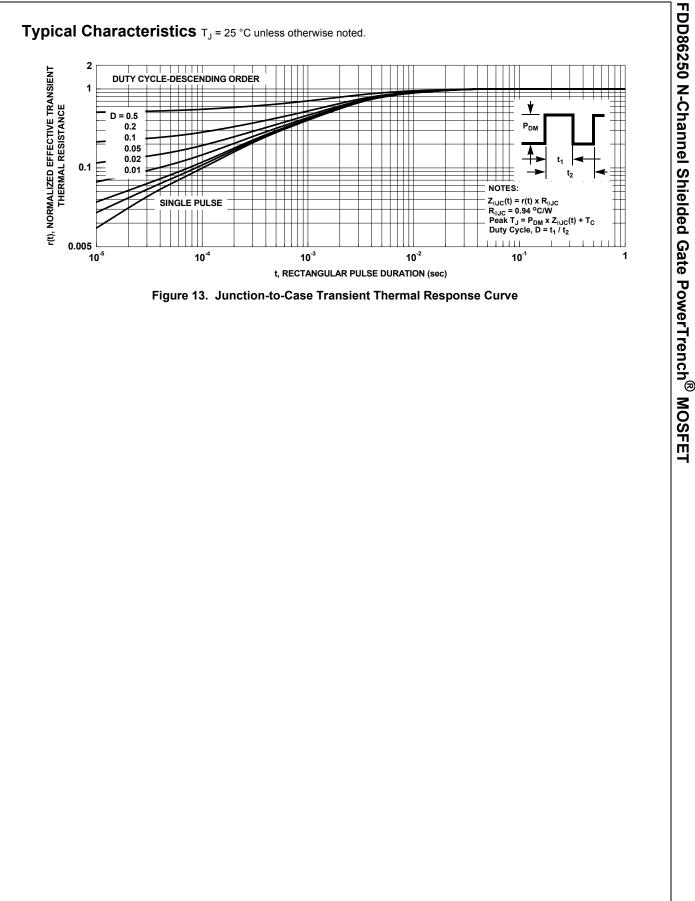
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Pulse Test: Pulse Width < 300 µs, Duty cycle < 2.0%.
Starting T_J = 25 °C, L = 1.0 mH, I_{AS} = 19 A, V_{DD} = 135 V, V_{GS} = 10 V.
Pulsed Id please refer to Fig 11 SOA graph for more details.
Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



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